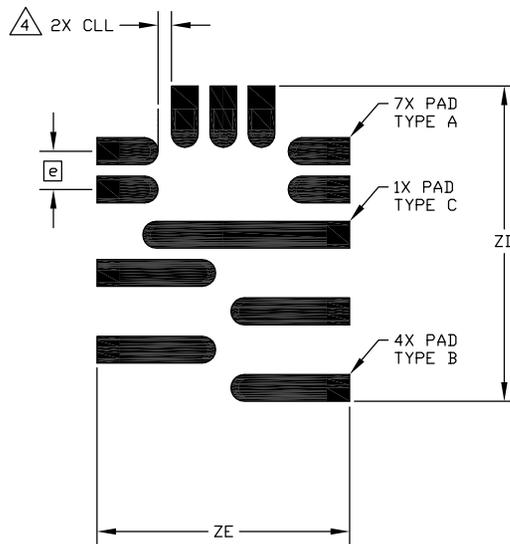
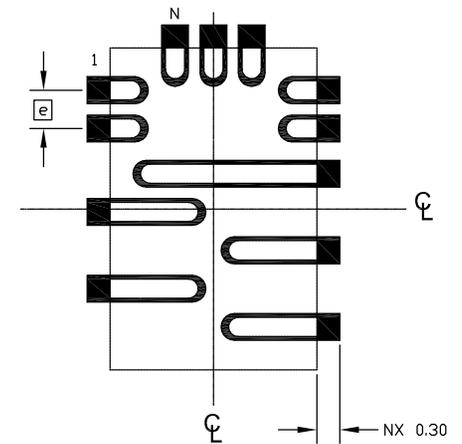


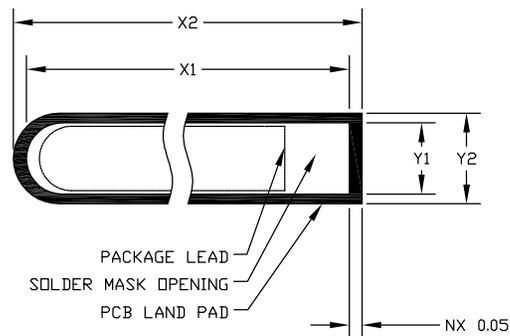
### RECOMMENDED LAND PATTERN



### PACKAGE OVERLAY



### PAD DETAIL INFORMATION



DIM	MIN	NOM	MAX	MIN	NOM	MAX
CLL		0.18 REF			.007 REF	
e		0.50 BSC			.020 BSC	
N		12 PINS			12 PINS	
ZD		4.12 REF			.162 REF	
ZE		3.30 REF			.130 REF	

DIM	TYPE A	TYPE B	TYPE C	TYPE A	TYPE B	TYPE C
Y1	0.28	0.28	0.28	.011	.011	.011
Y2	0.35	0.35	0.35	.014	.014	.014
X1	0.70	1.45	2.60	.028	.057	.102
X2	0.80	1.55	2.70	.031	.061	.106

### NOTES:

1. REFERENCE PKG. OUTLINE: 21-0972
2. LAND PATTERN COMPLIES TO: IPC7351A.
3. TOLERANCE: +/- 0.02 MM.
4. ALL DIMENSIONS APPLY TO PbFREE (+) PKG. CODE ONLY.
5. ALL DIMENSIONS IN MM.

—DRAWING NOT TO SCALE—



TITLE:  
PACKAGE LAND PATTERN,  
[P122A4F+1] FCQFN

APPROVAL

DOCUMENT CONTROL NO.

REV.

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This document (including dimensions, notes & specs) is a recommendation based on typical circuit board manufacturing parameters. Since land pattern design depend on many factors unknown to Maxim (eg. user's board manufacturing specs), user must determine suitability for use.

This document is subject to change without notice.

Contact technical support at <http://www.maximintegrated.com/support> for further questions.